

## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Vignia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/776,009	02/02/2001	Michael A. Vyvoda	MA-027	7430	
33971	7590 07/28/2003				
MATRIX SEMICONDUCTOR, INC.			EXAMINER		
	ΓBOULEVARD ARA, CA 95034		MAI, A	NH D	
			ART UNIT	PAPER NUMBER	
			2814		
			DATE MAILED: 07/28/2003	DATE MAILED: 07/28/2003	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
Advisory Action	09/776,009	VYVODA ET AL.				
, , , , , , , , , , , , , , , , , , ,	Examiner	Art Unit				
•	Anh D. Mai	2814				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address						
THE REPLY FILED 03 July 2003 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE. Therefore, further action by the applicant is required to avoid abandonment of this application. A proper reply to a final rejection under 37 CFR 1.113 may only be either: (1) a timely filed amendment which places the application in condition for allowance; (2) a timely filed Notice of Appeal (with appeal fee); or (3) a timely filed Request for Continued Examination (RCE) in compliance with 37 CFR 1.114.						
PERIOD FOR RE	PLY [check either a) or b)]					
a) The period for reply expiresmonths from the mailing date of the final rejection. b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection.  ONLY CHECK THIS BOX WHEN THE FIRST REPLY WAS FILED WITHIN TWO MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).  Extensions of time may be obtained under 37 CFR 1.136(a). The date on which the petition under 37 CFR 1.136(a) and the appropriate extension fee have been filed is the date for purposes of determining the period of extension and the corresponding amount of the fee. The appropriate extension fee under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the shortened statutory period for reply originally set in the final Office action; or (2) as set forth in (b) above, if checked. Any reply received by the Office later than three months after the mailing date of the final rejection, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
1. A Notice of Appeal was filed on Appellant's Brief must be filed within the period set forth in 37 CFR 1.192(a), or any extension thereof (37 CFR 1.191(d)), to avoid dismissal of the appeal.						
2. The proposed amendment(s) will not be entered because:						
(a) They raise new issues that would require further consideration and/or search (see NOTE below);						
(b) ☐ they raise the issue of new matter (see Note below);						
(c) they are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for appeal; and/or						
(d) they present additional claims without cancelli	ng a corresponding number of fi	nally rejected claims.				
NOTE:						
3. Applicant's reply has overcome the following reject	ion(s):					
4. Newly proposed or amended claim(s) would be allowable if submitted in a separate, timely filed amendment canceling the non-allowable claim(s).						
5. ☐ The a) ☐ affidavit, b) ☐ exhibit, or c) ☐ request for reconsideration has been considered but does NOT place the application in condition for allowance because: See Continuation Sheet.						
6. The affidavit or exhibit will NOT be considered because it is not directed SOLELY to issues which were newly raised by the Examiner in the final rejection.						
7. For purposes of Appeal, the proposed amendment(s) a) will not be entered or b) will be entered and an explanation of how the new or amended claims would be rejected is provided below or appended.						
The status of the claim(s) is (or will be) as follows:						
Claim(s) allowed:						
Claim(s) objected to:						
Claim(s) rejected:						
Claim(s) withdrawn from consideration:  8. The proposed drawing correction filed on is a) approved or /b) disapproved by the Examiner.						
9. Note the attached Information Disclosure Statement(s)( PTO-1449) Péper No(s)						
10. Other:	SUPERVISORY PR TECHNOLOGY	NMACY FLVIOLIER 'CENTER 2000				

f.



Continuation of 5. does NOT place the application in condition for allowance because: the combination of the references clearly renders claim 1 obvious as shown in the Office Action.

Applicants appear to contend that Lee does not specifically indicate the difficulty of removing particles following the CMP, thus, can not be used to reject the claimed invention.

However, the claimed invention is a semiconductor device, where the planar surface of the wafer comprises semiconductor material and oxide dielectric material, which is clearly tqughty Lee. Additionally, the exposed oxide on the surface of the semiconductor substrate clearly sufficient to attract enough water for a cleaning process. Furthermore, wet cleaning is not the only way to remove particles during a manufacturing process. Applicants fail to provide any facts that the surface of the semiconductor substrate of Lee does not attract enough water.

The rejections are therefore, maintained. .